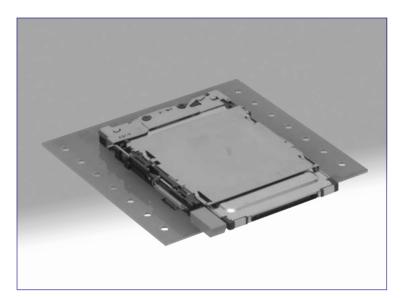
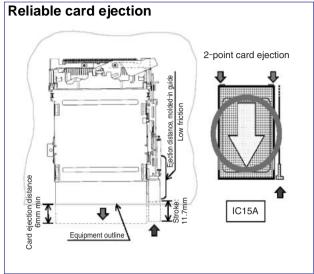


PC Card Single Slot SMT Connectors for the AV Market (that Support 5 V Cards)

IC15 Series





Features

1. Reliable card ejection

Designed for the front mounted Audio/Visual equipment the connectors eject the inserted card by applying force equally at each edge of the card (distance of 6 mm minimum), allowing easy hold of the card for the final removal.

2. New three-stage "Pop-Up" card ejection mechanism

The button does not protrude without the card being inserted, preventing it's damage when carrying the portable devices.

3. Secure board retention

Built-in 4 points of board retention posts assure that the card insertion shock is not transferred to the solder joints.

4. Supports lead-free environments

All components use lead-free materials.

Three-stage card ejection Damage prevention of ejection button.

Applications

DVD recorders, LCD TVs, PDP and other digital AV equipment

■Product Specifications

	Current rating	0.5A	Operating temperature range	-55℃ to +85℃ (Note 1)	Storage temperature range	-40℃ to +70℃ (Note 1)
Ratings	Voltage rating	125V AC	Operating humidity range	Relative humidity 95% max. (No condensation)	Storage humidity range	40% to 70% (Note 1)

Item	Specifications	Conditions	
Insulation resistance	100 MΩ min.	500 V DC	
2. Withstanding voltage	No flashover or insulation breakdown.	500 V AC / one minute	
3. Contact resistance	60 mΩ max. (Initial value)	1mA DC	
4. Vibration	No electrical discontinuity of 400 no or more	Frequency: 10 to 2000 Hz, single amplitude of 1.52 mm or	
4. Vibration	No electrical discontinuity of 100 ns or more.	acceleration of 147m/s²(peak), 4 hours / 3 axis	
5. Humidity	Insulation resistance: 100 MΩ min.	100 MΩ min. 96 hours at temperature of 40°C±2°C and humidity of 90% to 95%	
C. Tamparatura avala	Insulation resistance: 100 MΩ min.	Temperature: -55° $\rightarrow +5^{\circ}$ to $+35^{\circ}$ $\rightarrow +85^{\circ}$ $\rightarrow +5^{\circ}$ to $+35^{\circ}$	
6. Temperature cycle	insulation resistance. 100 MΩ min.	Duration: $30 \rightarrow 5$ max. $\rightarrow 30 \rightarrow 5$ max. (Minutes) 5 cycles	
7. Durability (mating/unmating)	Contact resistance: 20mΩ max. from initial value	10000 cycles at 400 to 600 cycles per hour	
8.Resistance to soldering heat	No deformation of any component. No offeet an contacto	Reflow: At the recommended temperature profile	
O. Nesistance to soldering heat	No deformation of any component. No affect on contacts.	Manual soldering: 300 ℃ for 3 seconds	

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers non- conducting condition of installed connectors in storage, shipment or during transportation.

■Materials/Finish

SMT unit

Component	Material	Finish	Remarks
Insulator	Heat resistant thermoplastic compound	Color: Black	UL94V-0
Contacts	Brass	Contact area: Gold plated	
Contacts		Termination area: Tin plated	
Ground/eject metal fittings	Stainless steel		
Positioning pin	Brass	Tin plated	

Guide unit

Component	Material	Finish	Remarks
Frame	PBT	Color: Black	UL94V-0
Cover/Metal components	Stainless		
Spring	Stainless steel		
Ejection button	ABS	Color: Gray	UL94V-HB

Note: Lead free products

■Ordering information

SMT unit

Series name: IC15	SF: Right angle surface mount
2 Stand off height	6 M: With Vacuum pick-up plate
A: 2.2mm	6 Ejection button type
Terminal type PDR: Reverse type (5V type)	EJL: Left button eject

Guide unit

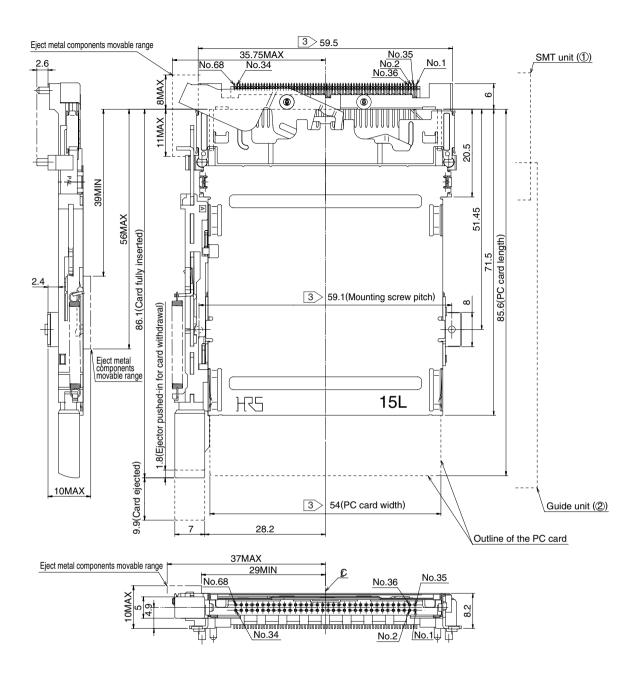
$$\frac{IC15}{0} \frac{A}{0} - \frac{G}{0} - \frac{P}{0} \frac{EJL}{0}$$

Series name:IC15	Eject mechanism codes
8 Stand off height	P: Pop-up button
A: 2.2mm	Ejection button type
G: Guide unit	EJL: Left button eject

Note: One SMT unit and one Guide unit constitute one assembly. They can not be ordered separate.

■Reverse type

Left Pop-up button type



Stand off height	SMT unit (1)		Guide unit (2)		Weight (g)
Stand on neight	Part Number	CL No.	Part Number	CL No.	Weight (g)
2.2mm	IC15A-PDR-SF-EJL	CL640-1500-7	- IC15A-G-PEJL CL640-1503-5		18.4
2.211111	IC15A-PDR-SFM-EJL	CL640-1502-2			18.7

^{1:} Above illustration shows the SMT unit and the Guide unit connected together.

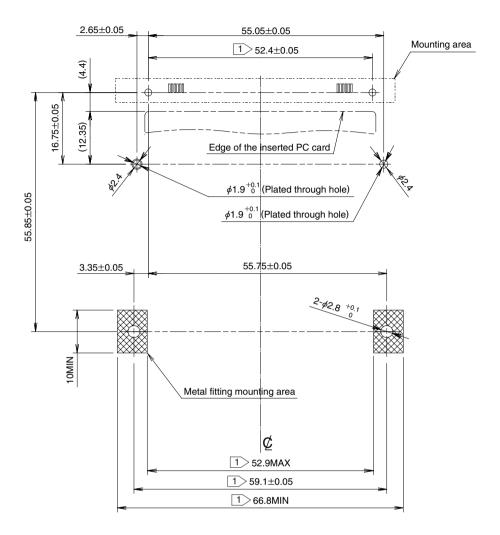
^{2:} Dimensions for card fitting are in accordance with "PC card standard".

³ Indicated dimensions are symmetrical to the center of the card insertion slot.

●PCB mounting pattern

Reverse type

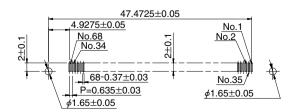
Stand off 2.2mm



Note 1> Indicated dimensions are symmetrical to the center of the card insertion slot.

▶ PCB mounting pattern (Enlarged detail)

Reverse type



● Method of Attachment to the Board and Precautions

(1) Exercise caution when handling the Guide unit.

If needed, re-position the push rod or the stroke arm as indicated in Fig.1

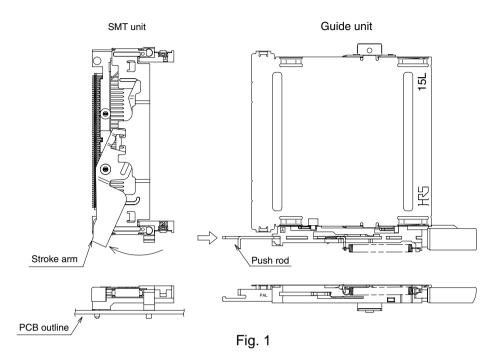




Fig. 2

(2) Align the left and right locking tabs (Fig. 4) of the Guide unit shield plate with the left and right openings on the SMT unit insulator. (Fig. 3)

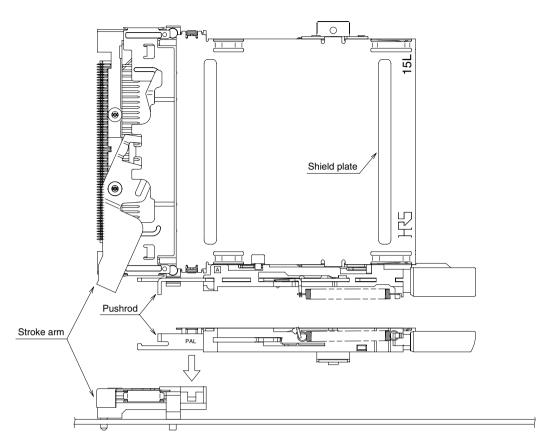


Fig. 3

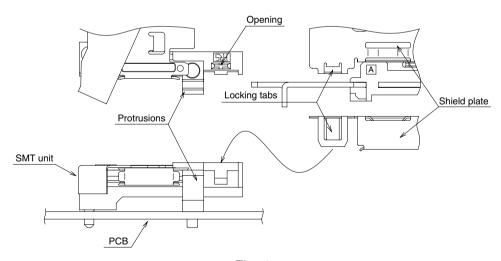
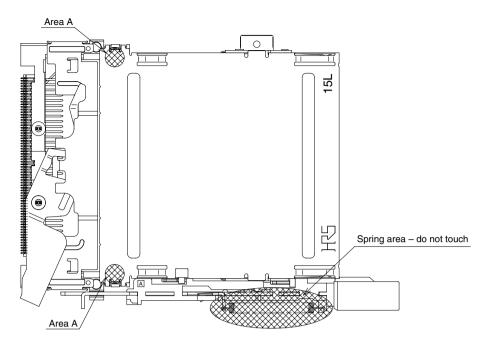


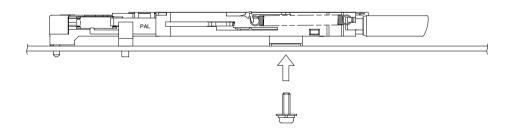
Fig. 4

(3) Assuring the correct alignment firmly press-down the shield plate of the Guide unit (at the areas "A") into the SMT unit until a loud "click" sound is heard. Both units should be now firmly locked together.



Note 1: When placing the Guide unit over the SMT unit, DO NOT press on any other area than "A".

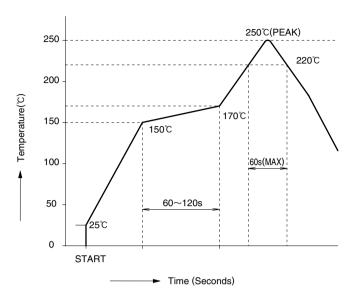
(4) Attach the Guide unit in two places using recommended screws (Not supplied).



Screw description	Recommended Fastening Torque		
M2×0.4	0.12~0.16 (N·m)		

- Note 2: When attaching the screws exercise caution not to deform the shield plate.
- Note 3: Do not insert/eject the PC card before the SMT unit and the Guide unit are fully mounted and locked.
- Note 4: Metal components of these connector assemblies have sharp edges. Use caution when handling and assembling.
- Note 5: Slight tool marks or cleaning fluid residue on the surfaces of the Guide unit will not affect form, fit or function of the assemblies.

▶Recommended temperature profile



Recommended conditions

- · Reflow system: IR reflow
- · Solder composition: Paste, 96.5%Sn/3.0%Ag/0.5%Cu (Flux content 10.5wt%)
- · Test board: Glass epoxy 80mm×125mm×1.6mm thick
- · Metal mask: 0.15mm thick

The temperature profiles are based on the above conditions.

In individual applications the actual temperature may vary, depending on solder paste type, volume/thickness and board size/thickness. Consult your solder paste and equipment manufacturer for specific recommendations.

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Hirose Electric:

IC15A-PDR-SF-EJL IC15A-PDR-SFM-EJL IC15A-G-PEJL